

10/010,696

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of:
Visvamohan Yegnashankaran et al.
Appln. No.: 10/010,696
Filed: December 5, 2001
For: MULTILEVEL METAL INTERCONNECT
WITH CAPACITIVE STRUCTURES
THAT ADJUST THE CAPACITANCE OF
THE INTERCONNECT

Group Art Unit: 2811
Examiner: VU, QUANG D
AMENDMENT IN RESPONSE TO OFFICE
ACTION MAILED SEPTEMBER 23, 2004

INTRODUCTORY COMMENTS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed September 23, 2004, please amend
the above-identified applications as follows:

Amendments to the Claims are reflected in the listing of claims which
begins on page 2 of this paper;

Remarks which begin on page 10 of this paper;

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the
United States Postal Service, postage prepaid, in an envelope,
addressed to Mail Stop Amendment, Commissioner for Patents,
P.O. Box 1450, Alexandria, VA 22313-1450 on 01-24-05.

Dated: January 24, 2005 By: Reuben R. King

AMENDMENT IN RESPONSE TO
OFFICE ACTION DATED SEPTEMBER 23, 2004

Atty. Docket No. 100-16201
(P05088-C1)